

2SK3378

Silicon N Channel MOS FET High Speed Switching

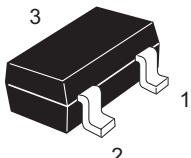
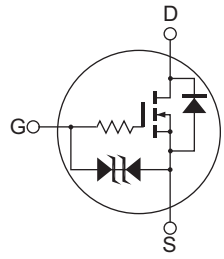
REJ03G1599-0200
(Previous: ADE-208-805)
Rev.2.00
Oct 23, 2007

Features

- Low on-resistance
 $R_{DS} = 2.7 \Omega$ typ. ($V_{GS} = 10 \text{ V}$, $I_D = 50 \text{ mA}$)
 $R_{DS} = 4.7 \Omega$ typ. ($V_{GS} = 4 \text{ V}$, $I_D = 20 \text{ mA}$)
- 4 V gate drive device.
- Small package (CMPAK)

Outline

RENESAS Package code: PTSP0003ZA-A
(Package name: CMPAK®)

1. Source
2. Gate
3. Drain

Note: Marking is EN

*CMPAK is a trademark of Renesas Technology Corp.

Absolute Maximum Rating

($T_a = 25^\circ\text{C}$)

Item	Symbol	Ratings	Unit
Drain to source voltage	V_{DSS}	30	V
Gate to source voltage	V_{GSS}	± 20	V
Drain current	I_D	100	mA
Drain peak current	$I_{D(\text{pulse})}$ ^{Note 1}	400	mA
Body-drain diode reverse drain current	I_{DR}	100	mA
Channel dissipation	P_{ch} ^{Note 2}	300	mW
Channel temperature	T_{ch}	150	$^\circ\text{C}$
Storage temperature	T_{stg}	-55 to +150	$^\circ\text{C}$

Note: 1. $PW \leq 10 \mu\text{s}$, duty cycle $\leq 1\%$
 2. Value on the alumina ceramic board (12.5 x 20 x 0.7 mm)

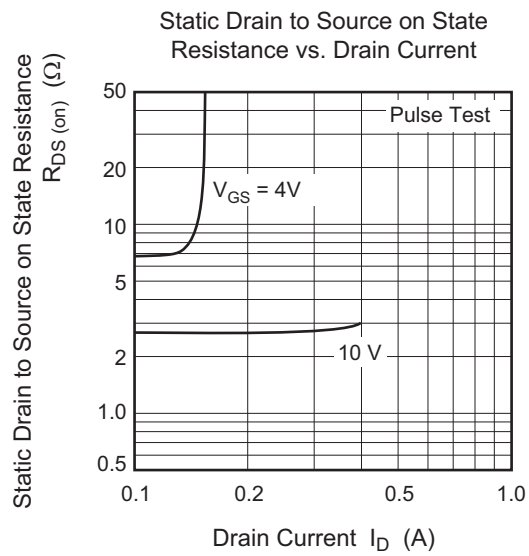
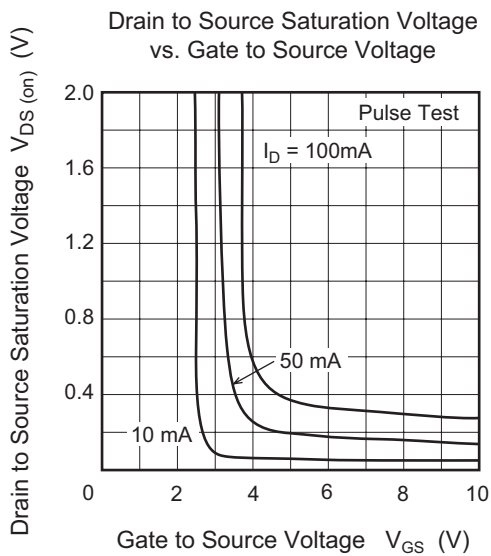
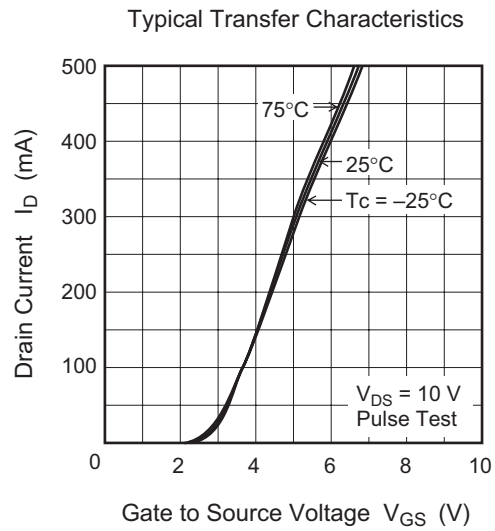
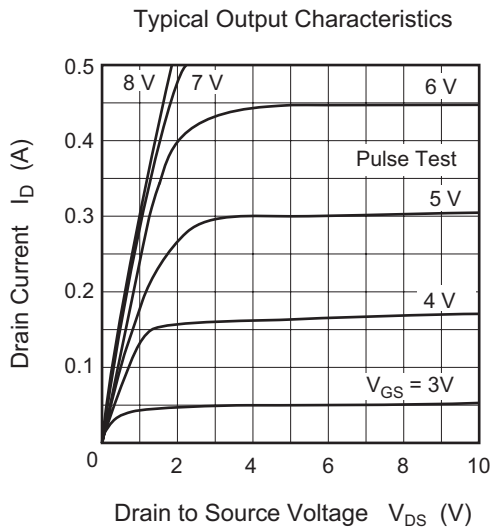
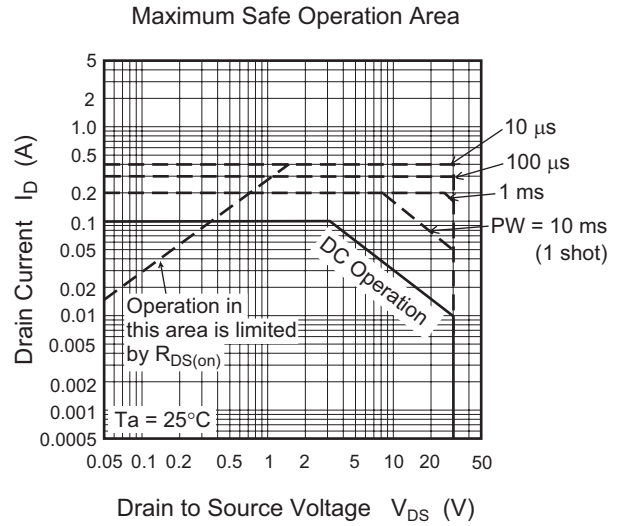
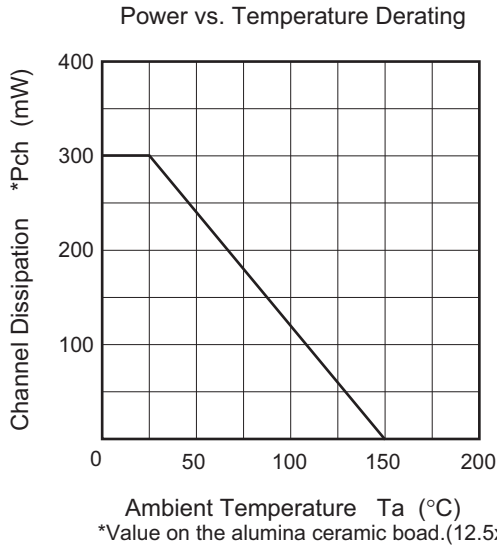
Electrical Characteristics

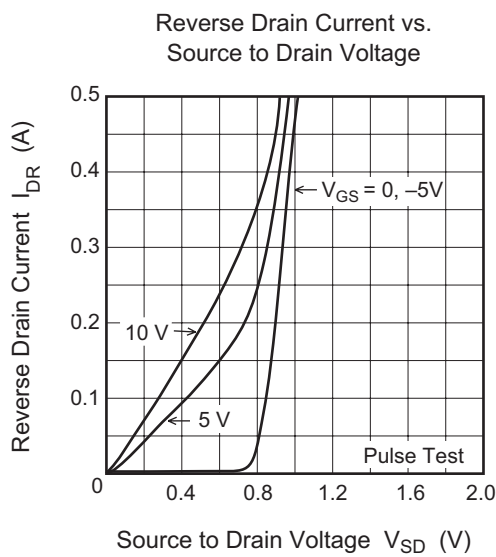
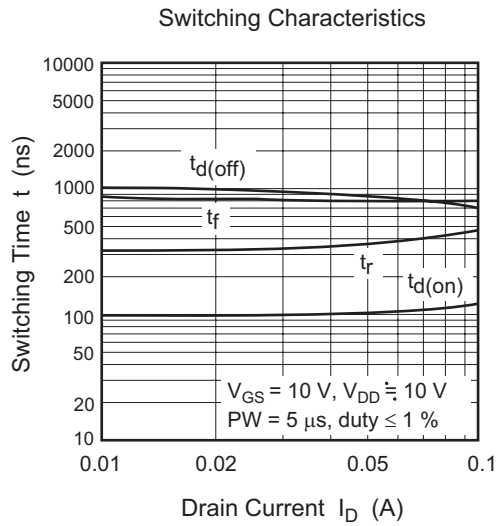
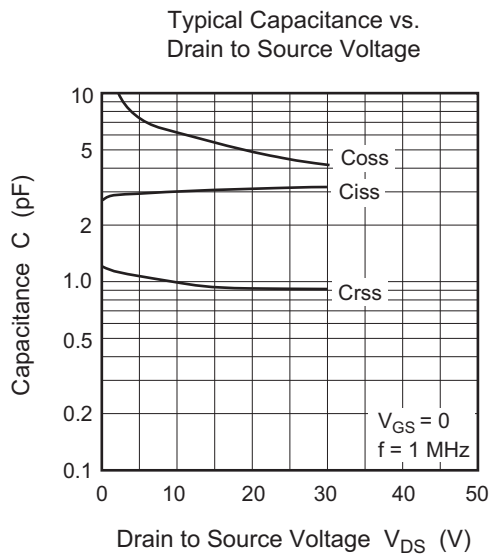
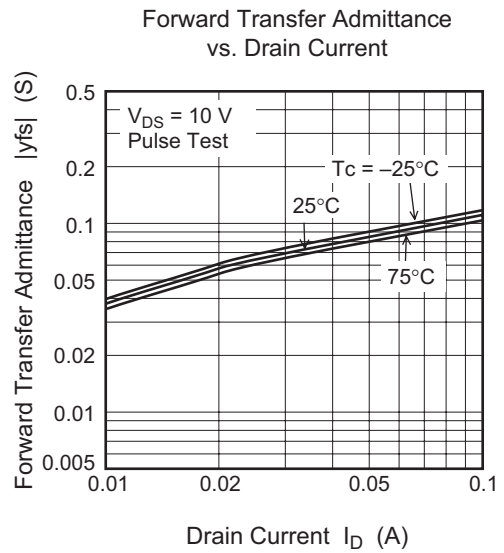
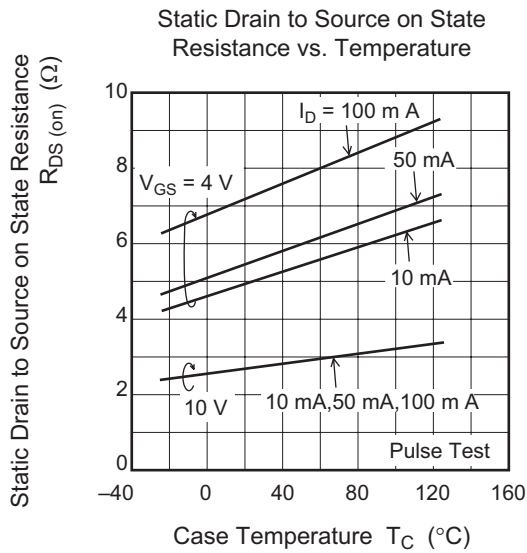
(Ta = 25°C)

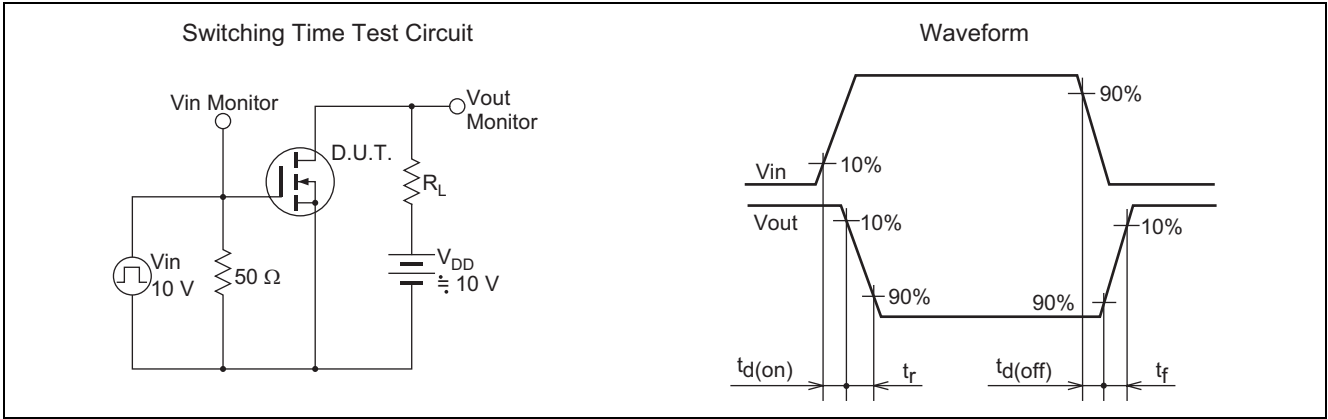
Item	Symbol	Min	Typ	Max	Unit	Test Conditions
Drain to source breakdown voltage	$V_{(BR)DSS}$	30	—	—	V	$I_D = 100 \mu A, V_{GS} = 0$
Gate to source breakdown voltage	$V_{(BR)GSS}$	± 20	—	—	V	$I_G = \pm 100 \mu A, V_{DS} = 0$
Gate to source leak current	I_{GSS}	—	—	± 5	μA	$V_{GS} = \pm 16 V, V_{DS} = 0$
Zero gate voltage drain current	I_{DSS}	—	—	1	μA	$V_{DS} = 30 V, V_{GS} = 0$
Gate to source cutoff voltage	$V_{GS(off)}$	1.3	—	2.3	V	$I_D = 10 \mu A, V_{DS} = 5 V$
Static drain to source on state resistance	$R_{DS(on)}$	—	2.7	3.5	Ω	$I_D = 50 mA, V_{GS} = 10 V$ ^{Note 3}
	$R_{DS(on)}$	—	4.7	7.0	Ω	$I_D = 20 mA, V_{GS} = 4 V$ ^{Note 3}
Forward transfer admittance	$ y_{fs} $	55	85	—	mS	$I_D = 50 mA, V_{DS} = 10 V$ ^{Note 3}
Input capacitance	C_{iss}	—	3	—	pF	$V_{DS} = 10 V$
Output capacitance	C_{oss}	—	8	—	pF	$V_{GS} = 0$
Reverse transfer capacitance	C_{rss}	—	1	—	pF	$f = 1 MHz$
Turn-on delay time	$t_{d(on)}$	—	100	—	ns	$I_D = 50 mA, V_{GS} = 10 V$
Rise time	t_r	—	330	—	ns	$R_L = 200 \Omega$
Turn-off delay time	$t_{d(off)}$	—	1150	—	ns	
Fall time	t_f	—	940	—	ns	

Notes: 3. Pulse test

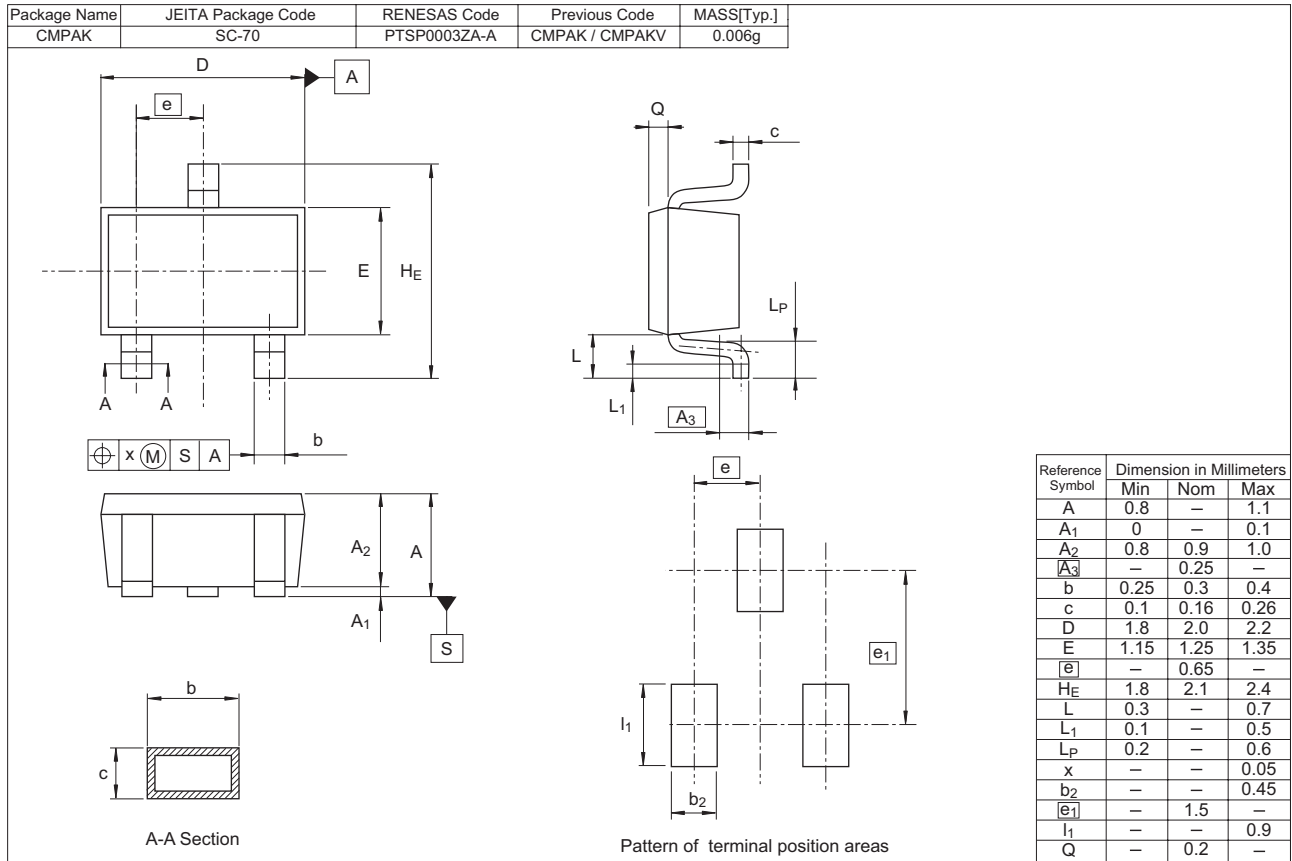
Main Characteristics







Package Dimensions



Ordering Information

Part No.	Quantity	Shipping Container
2SK3378ENTL-E	3000 pcs	Taping
2SK3378ENTR-E	3000 pcs	Taping

Notes:

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Renesas Technology America, Inc.
450 Holger Way, San Jose, CA 95134-1368, U.S.A
Tel: <1> (408) 382-7500, Fax: <1> (408) 382-7501

Renesas Technology Europe Limited
Dukes Meadow, Millboard Road, Bourne End, Buckinghamshire, SL8 5FH, U.K.
Tel: <44> (1628) 585-100, Fax: <44> (1628) 585-900

Renesas Technology (Shanghai) Co., Ltd.
Unit 204, 205, AZIACenter, No.1233 Lujiazui Ring Rd, Pudong District, Shanghai, China 200120
Tel: <86> (21) 5877-1818, Fax: <86> (21) 6887-7898

Renesas Technology Hong Kong Ltd.
7th Floor, North Tower, World Finance Centre, Harbour City, 1 Canton Road, Tsimshatsui, Kowloon, Hong Kong
Tel: <852> 2265-6688, Fax: <852> 2730-6071

Renesas Technology Taiwan Co., Ltd.
10th Floor, No.99, Fushing North Road, Taipei, Taiwan
Tel: <886> (2) 2715-2888, Fax: <886> (2) 2713-2999

Renesas Technology Singapore Pte. Ltd.
1 Harbour Front Avenue, #06-10, Keppel Bay Tower, Singapore 098632
Tel: <65> 6213-0200, Fax: <65> 6278-8001

Renesas Technology Korea Co., Ltd.
Kukje Center Bldg. 18th Fl., 191, 2-ka, Hangang-ro, Yongsan-ku, Seoul 140-702, Korea
Tel: <82> (2) 796-3115, Fax: <82> (2) 796-2145

Renesas Technology Malaysia Sdn. Bhd
Unit 906, Block B, Menara Amcorp, Amcorp Trade Centre, No.18, Jalan Persiaran Barat, 46050 Petaling Jaya, Selangor Darul Ehsan, Malaysia
Tel: <603> 7955-9390, Fax: <603> 7955-9510